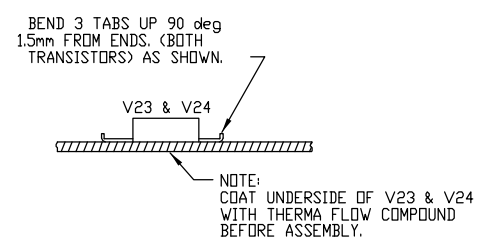
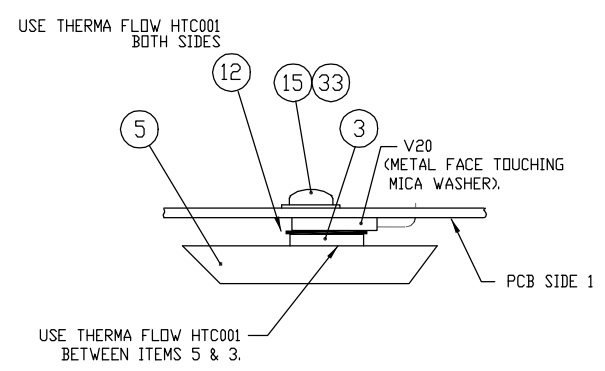
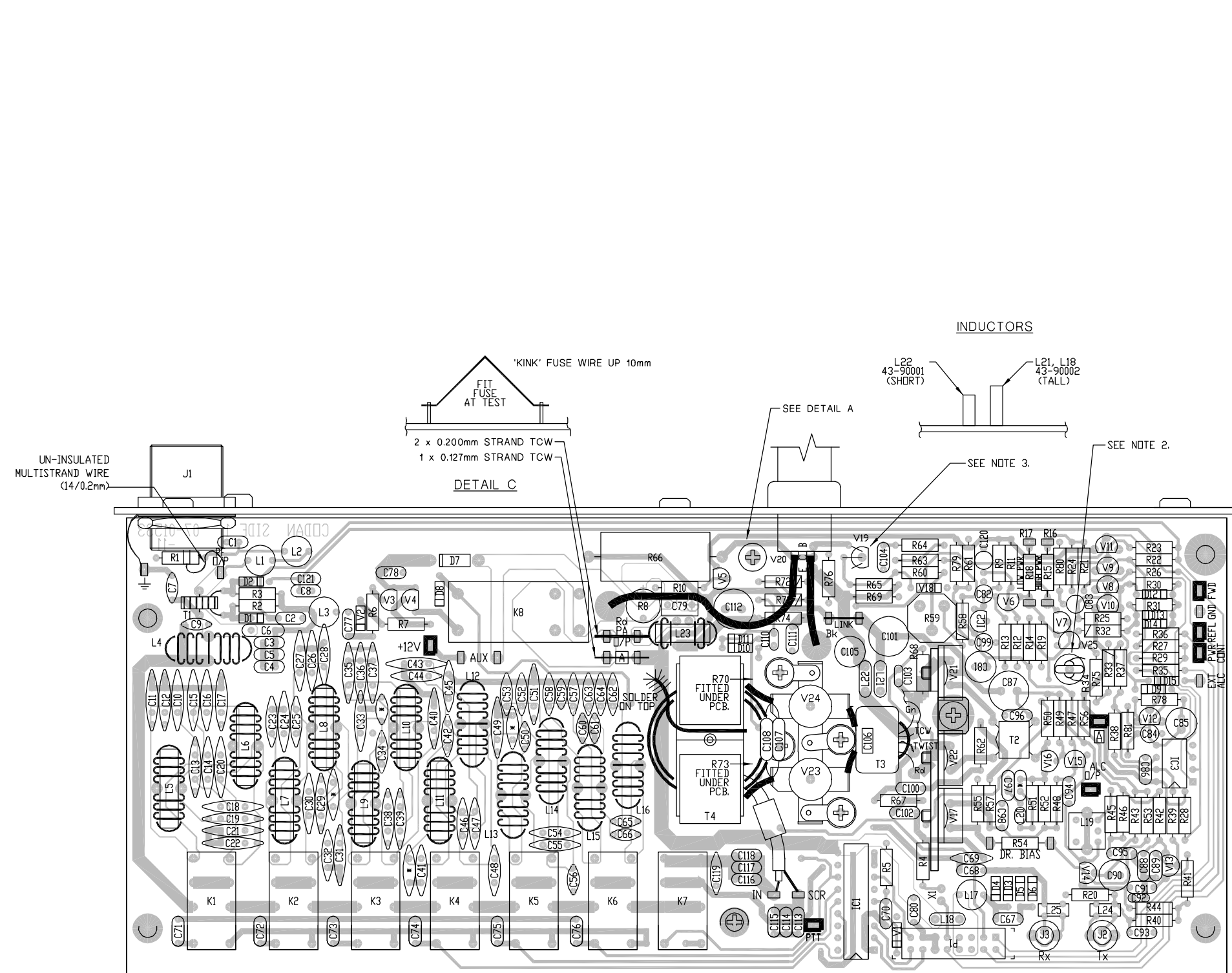
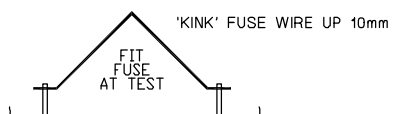


DO NOT SCALE

A
B
C
D
E
F
G
H



INDUCTORS



- NOTES:
1. ALL LINKS ARE 22 SWG.
 2. FIT HEATSHRINK SLEEVE (ITEM 28) x 8mm OVER R34, ENSURING THAT THE TOP IS COVERED. COAT WITH THERMA FLOW COMPOUND, INSERT INTO HEATSINK (ITEM 5) & SOLDER.
 3. COAT V19 WITH THERMA FLOW COMPOUND, INSERT INTO HEATSINK & SOLDER.
 4. C106 (1n SMT CAPACITOR) IS MOUNTED UNDER T3.

ISSUE B
ITEM 25 ADDED.
C/R 23839
21-03-94 NJA

ISSUE C
VAR. CHNGES.
C/R 24015
11-10-94 NJA

ISSUE D
L21 WAS L121
ARROWS -
STANDARDISED.
C/R 24078
12-01-95 CM

ISSUE E
VAR. CHNGES.
C/R 24037
C/R 24102
C/R 24104
C/R 24107
12-01-95 CM

ISSUE 2
R15 & R18 VAL.
VALUES ADDED.
C/R 24124
28-02-95 CM

ISSUE 3
D15 & EXT ALC
LDUPDT ADDED.
PCB WAS ISS 3
R41 & R44 WERE
330R
C/R 24383
13-10-95 NJA

ISSUE 4
PCB WAS ISS 5
C122-C126 ADDED
C106 WAS 470p
D3-DR WERE
BA423.
NOTE 7 ADDED.
C/R 24478
20-02-96 NJA

ISSUE 5
C22 WAS 180p
C/R 24547
15-05-96 NJA

ISSUE 6
44-70468 WAS
Rd-Dr.
12-06-96 JFB

ISSUE 7
PCB WAS ISS 5
25-07-96
NOTE 5 (SHT2)
CHANGED
C/R 24779
08-01-97 RRU

ISSUE 8
PCB WAS ISS 7
C9, C49, C50 &
V2 MOVED.
DETAIL E
SHOWED MFR260
C/R 24945
25-03-97 NJA

ISSUE 9
PCB WAS ISS 9
C/R 25023
13-06-97 BCL

ISSUE 10
REDRWN ON 2
SHTS.
ITEMS 10,11,12,
17 & 14 RMVD.
ITEMS 33 & 35
ADDED.
C/R 25026
25-08-97 BCL

ISSUE 11
VARIANT TABLE
ADDED.
C/R 25130
03-10-97 CAE

ISSUE 12
R34 ROTATED.
PCB WAS -09
C/R 25329
13-05-98 NJA

ISSUE 13
PCB WAS -10
T4 ASSY MOVED
C/R 25542
C/R 25539
C1 MOVED
C/R 25585
PB 28-9-98

PCB 07-01533-11

TSM FILE No. 08\04963_13.DWG

	SCALE	2:1	© CODAN PTY LTD, A.C.N. 007 590 605: 1997 TITLE PA AND FILTER FINAL ASSEMBLY
	DRN	CG	
MATERIAL	CHKD	NJA	11-02-94
	APPD	CM	12-01-95
FINISH	TOLERANCES		A1
	UNLESS OTHERWISE STATED		
	2 PLACES DEC.	±0.25	ISS
	1 PLACE DEC.	±0.5	
	0 PLACE DEC.	±1	
	ANGULAR	±2°	11 12 13
DIMENSIONS IN mm			SHT. 1 OF 1